Application No.: 10/017,734

## APPENDIX: MARKED UP VERSION OF SPECIFICATION AND CLAIM AMENDMENTS

Please amend claims 2-5 as follows:

- 2. The [switching device]  $\underline{\text{method}}$  as defined in claim [1]  $\underline{6}$  wherein the thickness of the backside  $p^+$  emitter is approximately between 0.2 and 1  $\mu$ m.
- 3. The [switching device]  $\underline{\text{method}}$  as defined in claim [1]  $\underline{6}$  wherein the implanting dose of the backside  $p^+$  emitter is approximately between  $1 \times 10^{11}$  and  $1 \times 10^{17}$  cm<sup>-2</sup>.
- 4. The [switching device]  $\underline{\text{method}}$  as defined in claim [1]  $\underline{6}$  wherein the thickness of the n-type residual diffused-layer contained in the n-type base is approximately between 5 and 50  $\mu$ m.
- 5. The [switching device] method as defined in claim [1]  $\underline{6}$  wherein the doping concentration of the n-type residual diffused-layer is in a range of approximately  $1 \times 10^{14} \sim 1 \times 10^{17}$  cm<sup>-3</sup> at the interface of the residual layer and the backside p<sup>+</sup> emitter.